Vishay Siliconix

P-Channel 20 V (D-S) MOSFET



Marking Code: P6

PRODUCT SUMMARY						
V _{DS} (V)	-20					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5 \text{ V}$	0.061					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -2.5 \text{ V}$	0.080					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -1.8 \text{ V}$	0.110					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -1.5 \text{ V}$	0.165					
Q _g typ. (nC)	7.6					
I _D (A) ^a	-4.4					
Configuration	Single					

FEATURES

- TrenchFET® power MOSFET
- 100% R_g tested
- Typical ESD performance 2000 V
- Built in ESD protection with Zener Diode
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

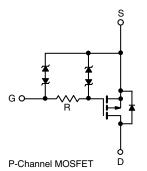


RoHS COMPLIANT

HALOGEN FREE

APPLICATIONS

 Load switch for portable devices



ORDERING INFORMATION				
Package	SOT-23			
Lead (Pb)-free and halogen-free	Si2377EDS-T1-GE3			

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-20	v
Gate-source voltage	V _{GS}	± 8		
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		-4.4	
	T _C = 70 °C		3.5	
	T _A = 25 °C	I _D	-3.7 b, c	
	T _A = 70 °C		-2.9 b, c	A
Pulsed drain current		I _{DM}	-20	
Continuous source-drain diode current	T _C = 25 °C		-1.5	
	T _A = 25 °C	I _S	-1 b, c	
Maximum power dissipation	T _C = 25 °C		1.8	
	T _C = 70 °C		1.1	14/
	T _A = 25 °C	P _D	1.25 ^{b, c}	W
	T _A = 70 °C		0.8 b, c	7
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C
Soldering recommendations (peak temperature		260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 5 s	R_{thJA}	80	100	°C ///	
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	55	70	°C/W	

Notes

- a. $T_C = 25$ °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. Maximum under steady state conditions is 130 °C/W



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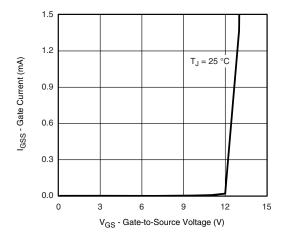
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static						•	
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-20	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	-13	-		
V _{GS(th)} temperature coefficient	ΔV _{GS(th)} /T _J	I _D = -250 μA	-	2.5	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-0.4	-	-1	V	
Cata acuraa laakaga	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	-	-	± 6	μΑ	
Gate-source leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$	-	-	± 0.5		
Zoro gato voltago drain current	l	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1		
Zero gate voltage drain current	I _{DSS}	V_{DS} = -20 V, V_{GS} = 0 V, T_J = 55 °C	-	-	-10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-15	-	-	Α	
		$V_{GS} = -4.5 \text{ V}, I_D = -3.2 \text{ A}$	-	0.050	0.061	Ω	
Drain aguras en eteta registance a		$V_{GS} = -2.5 \text{ V}, I_D = -2.8 \text{ A}$	-	0.065	0.080		
Drain-source on-state resistance a	R _{DS(on)}	V _{GS} = -1.8 V, I _D = -1.5 A	-	0.090	0.110		
		V _{GS} = -1.5 V, I _D = -0.5 A	-	0.110	0.165		
Forward transconductance a	9 _{fs}	$V_{DS} = -10 \text{ V}, I_D = -3.2 \text{ A}$	-	12	-	S	
Dynamic ^b							
Total gate charge	Qg	$V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_D = -5.3 \text{ A}$	-	14	21		
			-	7.6	12	nC	
Gate-source charge	Q_{gs}	V_{DS} = -10 V, V_{GS} = -4.5 V, I_D = -5.3 A	1	0.8	-	nC	
Gate-drain charge	Q_{gd}		1	3.1	-		
Gate resistance	R_g	f = 1 MHz	0.4	2	4	kΩ	
Turn-on delay time	t _{d(on)}		1	0.2	0.3		
Rise time	t _r	V_{DD} = -10 V, R_L = 2.3 Ω	-	1	1.5		
Turn-off delay time	t _{d(off)}	$I_D\cong$ -4.3 A, $V_{GEN}=$ -4.5 V, $R_g=$ 1 Ω	-	4	6		
Fall time	t _f		1	2	3		
Turn-on delay time	t _{d(on)}		1	0.09	0.14	μs -	
Rise time	t _r	V_{DD} = -10 V, R_L = 2.3 Ω	-	0.4	0.6		
Turn-off delay time	t _{d(off)}	$I_D\cong$ -4.3 A, V_{GEN} = -8 V, R_g = 1 Ω	-	5.2	7.8		
Fall time	t _f		-	2.3	3.5		
Drain-Source Body Diode Characterist	ics						
Continuous source-drain diode current	IS	T _C = 25 °C	-	-	-1.5	^	
Pulse diode forward current	I _{SM}		-	-	-20	A	
Body diode voltage	V_{SD}	$I_{S} = -3 \text{ A}, V_{GS} = 0 \text{ V}$	-	-0.8	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	30	60	ns	
Body diode reverse recovery charge	Q _{rr}	$I_F = -3 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	20	40	nC	
Reverse recovery fall time	t _a	$T_J = 25 ^{\circ}C$	-	13	-		
Reverse recovery rise time	t _b		_	17	 	ns	

Notes

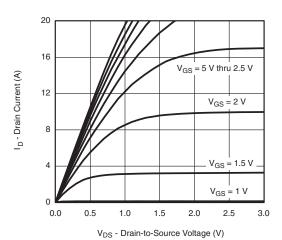
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2%
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

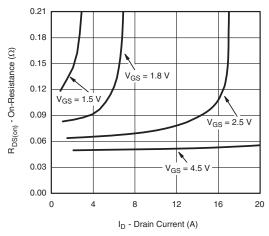




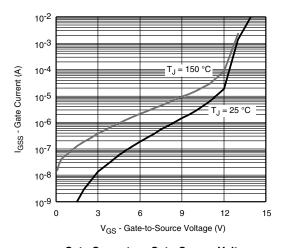
Gate Current vs. Gate-Source Voltage



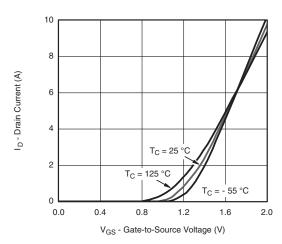
Output Characteristics



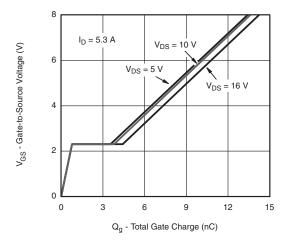
On-Resistance vs. Drain Current



Gate Current vs. Gate-Source Voltage

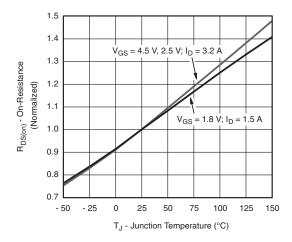


Transfer Characteristics

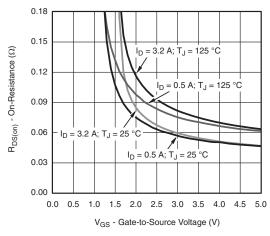


Gate Charge

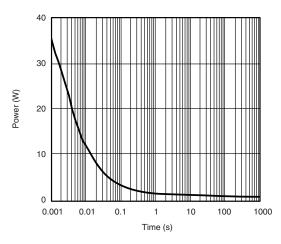




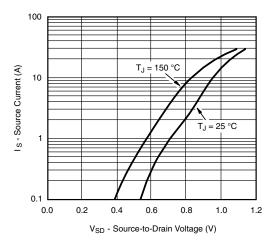
On-Resistance vs. Junction Temperature



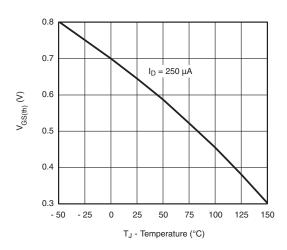
On-Resistance vs. Gate-to-Source Voltage



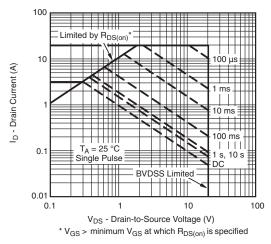
Single Pulse Power, Junction-to-Ambient



Source-Drain Diode Forward Voltage

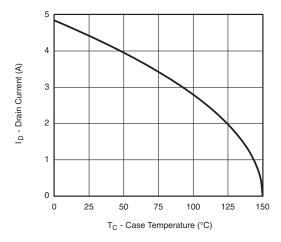


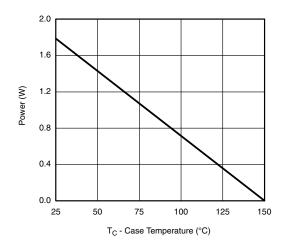
Threshold Voltage



Safe Operating Area, Junction-to-Ambient





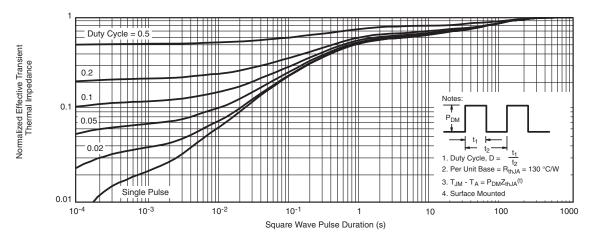


Current Derating ^a

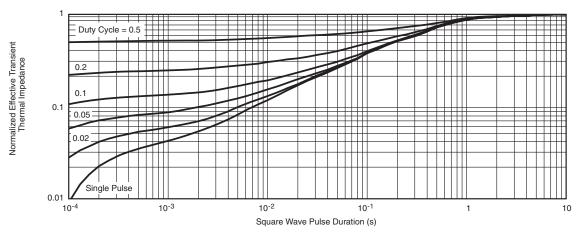
Power Derating

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for silicon technology and package reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg265905.

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SOT-23 (TO-236): 3-LEAD







Dim	MILLI	METERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
FCN: S-03946-Rev K 09-	lul-01	•			

ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479

Document Number: 71196 www.vishay.com 09-Jul-01



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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